# 2SC3338

## Silicon NPN Epitaxial

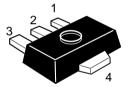
# **HITACHI**

#### **Application**

UHF / VHF wide band amplifier

#### Outline

UPAK



- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector (Flange)



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### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

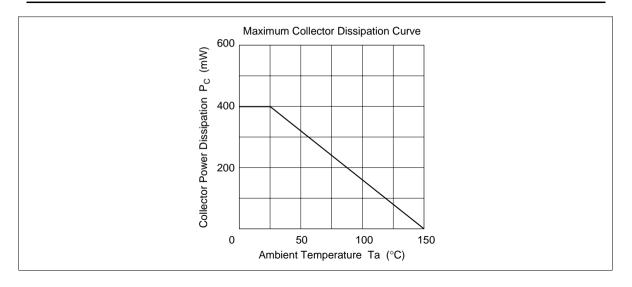
Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	20	V
Collector to emitter voltage	V <sub>CEO</sub>	12	V
Emitter to base voltage	V <sub>EBO</sub>	3	V
Collector current	Ic	50	mA
Collector power dissipation	P <sub>c</sub>	400	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

### **Electrical Characteristics** (Ta = 25°C)

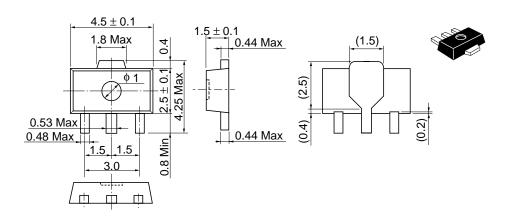
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	20	_	_	V	$I_{\rm C} = 10 \; \mu \text{A}, \; I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	12	_	_	V	I <sub>C</sub> = 1 mA, R <sub>BE</sub> = ∞
Emitter cutoff current	I <sub>EBO</sub>	_	_	10	μΑ	$V_{EB} = 3 \text{ V}, I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_		0.5	μΑ	V <sub>CB</sub> = 15 V, I <sub>C</sub> = 0
DC current transfer ratio	h <sub>FE</sub>	30	90	200		$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA}$
Collector output capacitance	Cob	_	1.0	1.5	pF	$V_{CB} = 5 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Gain bandwidth product	$f_{T}$	3.5	4.5	_	GHz	$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA}$
Power gain	PG	_	8.2	_	dB	$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA},$ f = 900 MHz
Noise figure	NF	_	2.0	_	dB	$V_{CE} = 5 \text{ V}, I_{C} = 5 \text{ mA},$ f = 900 MHz

Note: Marking is "AR".

See characteristic curves of 2SC3127.



Unit: mm



Hitachi Code	UPAK
JEDEC	_
EIAJ	Conforms
Weight (reference value)	0.050 g

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